

July 1999 Revised November 2001

### **74VCX38**

# Low Voltage Quad 2-Input NAND Gate with Open Drain Outputs and 3.6V Tolerant Inputs and Outputs

#### **General Description**

The VCX38 contains four 2-input NAND gates with open drain outputs. This product is designed for low voltage (1.4V to 3.6V)  $V_{CC}$  applications with I/O compatibility up to 3.6V.

The VCX38 is fabricated with advanced CMOS technology to achieve high-speed operation while maintaining CMOS low power dissipation.

#### **Features**

- 1.4V-3.6V V<sub>CC</sub> supply operation
- 3.6V tolerant inputs and outputs
- t<sub>PD</sub>

2.8 ns max for 3.0V to 3.6V  $\rm V_{\rm CC}$ 

- Power-Off high impedance inputs and outputs
- Static Drive (I<sub>OL</sub>) +24 mA @ 3.0V V<sub>CC</sub>
- Uses patented Quiet Series™ noise/EMI reduction
- circuitry
- Latchup performance exceeds 300 mA
- ESD performance:

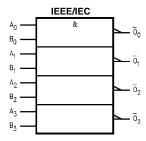
Human body model > 2000V Machine model > 250V

### **Ordering Code:**

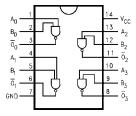
Order Number	Package Number	Package Description
74VCX38M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VCX38MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

### **Logic Symbol**



### **Connection Diagram**



### **Pin Descriptions**

Pin Names	Description
A <sub>n</sub> , B <sub>n</sub>	Inputs
$\overline{O}_n$	Outputs

Quiet Series™ is a trademark of Fairchild Semiconductor Corporation.

### Absolute Maximum Ratings(Note 1)

## Supply Voltage ( $V_{CC}$ ) -0.5V to +4.6V DC Input Voltage ( $V_I$ ) -0.5V to +4.6V Output Voltage ( $V_O$ ) (Note 2) -0.5V to +4.6V

DC Input Diode Current (I<sub>IK</sub>)

 $V_I < 0V$  DC Output Diode Current ( $I_{OK}$ )

 $V_{\rm O} < 0{\rm V}$  —50 mA DC Output Source/Sink Current (I $_{\rm OL}$ ) +50 mA DC V $_{\rm CC}$  or Ground Current per ±100 mA

Supply Pin ( $I_{CC}$  or Ground)

Storage Temperature Range ( $T_{stg}$ )  $-65^{\circ}C$  to  $+150^{\circ}C$ 

### Recommended Operating Conditions (Note 3)

Power Supply

-50 mA

Output Current in I<sub>OL</sub>

 $\begin{array}{lll} \mbox{V}_{CC} = 3.0 \mbox{V to } 3.6 \mbox{V} & +24 \mbox{ mA} \\ \mbox{V}_{CC} = 2.3 \mbox{V to } 2.7 \mbox{V} & +18 \mbox{ mA} \\ \mbox{V}_{CC} = 1.65 \mbox{V to } 2.3 \mbox{V} & +6 \mbox{ mA} \end{array}$ 

 $\label{eq:VCC} V_{CC} = 1.4 \mbox{V to } 1.6 \mbox{V} $$+2 \mbox{ mA}$$$  Free Air Operating Temperature (T\_A)  $-40 \mbox{°C}$  to +85  $\mbox{°C}$ 

Minimum Input Edge Rate (Δt/ΔV)

 $V_{in} = 0.8V \text{ to } 2.0V, V_{CC} = 3.0V$  10 ns/V

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: I<sub>O</sub> Absolute Maximum Rating must be observed.

Note 3: Floating or unused inputs must be held HIGH or LOW

#### **DC Electrical Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Units
V <sub>IH</sub>	HIGH Level Input Voltage		2.7 - 3.6	2.0		
			2.3 - 2.7	1.6		V
			1.65 - 2.3	$0.65 \times V_{CC}$		•
			1.4 - 1.6	$0.65 \times V_{CC}$		
V <sub>IL</sub>	LOW Level Input Voltage		2.7 - 3.6		0.8	
			2.3 - 2.7		0.7	V
			1.65 - 2.3		$0.35 \times V_{CC}$	V
			1.4 - 1.6		$0.35 \times V_{CC}$	
V <sub>OL</sub>	LOW Level Output Voltage	$I_{OL} = 100 \mu A$	2.7 - 3.6		0.2	
		I <sub>OL</sub> = 12 mA	2.7		0.4	
		I <sub>OL</sub> = 18 mA	3.0		0.4	
		I <sub>OL</sub> = 24 mA	3.0		0.55	
		$I_{OL} = 100 \mu A$	2.3 - 2.7		0.2	
		I <sub>OL</sub> = 12 mA	2.3		0.4	V
		I <sub>OL</sub> = 18 mA	2.3		0.6	
		I <sub>OL</sub> = 100 μA	1.65 - 2.3		0.2	
		I <sub>OL</sub> = 6 mA	1.65		0.3	
		I <sub>OL</sub> = 100 μA	1.4 - 1.6		0.2	
		I <sub>OL</sub> = 2 mA	1.4		0.35	
l <sub>l</sub>	Input Leakage Current	$0 \le V_1 \le 3.6V$	1.4 - 3.6		±5.0	μА
l <sub>OFF</sub>	Power-Off Leakage Current	$0 \le (V_I, V_O) \le 3.6V$	0		10	μА
I <sub>cc</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	1.4 - 3.6		20	^
		$V_{CC} \le (V_I) \le 3.6V$	1.4 - 3.6		±20	μА
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	$V_{IH} = V_{CC} - 0.6V$	2.7 - 3.6		750	μА
I <sub>OHZ</sub>	Off State Current	V <sub>O</sub> = 3.6	1.4 - 3.6		10	μΑ

### AC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	V <sub>CC</sub>	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Figure
Cymbol			(V)	Min	Max	Oillio	Number
t <sub>PZL</sub> , t <sub>PLZ</sub>	Propagation Delay	$C_L = 30 \text{ pF, } R_L = 500\Omega$	$3.3 \pm 0.3$	0.6	2.8		
			$2.5 \pm 0.2$	0.8	3.7		Figures 1, 2
			$1.8\pm0.15$	1.0	6.7	ns	., _
		$C_L = 15 \text{ pF}, R_L = 2k\Omega$	1.5 ± 0.1	1.0	13.4		Figures 3, 4
toshl	Output to Output Skew	$C_L = 30 \text{ pF}, R_L = 500\Omega$	$3.3\pm0.3$		0.5		
toslh	(Note 5)		$2.5\pm0.2$		0.5	ns	
			$1.8 \pm 0.15$		0.75	115	
		$C_L = 15 \text{ pF}, R_L = 2k\Omega$	$1.5 \pm 0.1$		1.5		

Note 4: For  $C_L = 50_P F$ , add approximately 300 ps to the 30 pF AC maximum specification.

Note 5: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

### **Dynamic Switching Characteristics**

	Parameter		Conditions	V <sub>CC</sub>	$T_A = +25^{\circ}C$	Units
Farameter		Conditions	(V)	Typical	Onito	
Output Dyna	amic Peak V <sub>OL</sub>	CL	$L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	0.25	
				2.5	0.6	V
				3.3	0.8	
Output Dyna	amic Valley V <sub>OL</sub>	CL	$L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	-0.25	
				2.5	-0.6	V
				3.3	-0.8	
Output Dyna	amic Valley V <sub>OL</sub>	CL	$_{L}$ = 30 pF, $V_{IH}$ = $V_{CC}$ , $V_{IL}$ = 0V	3.3 1.8 2.5	0.8 -0.25 -0.6	

### Capacitance

Symbol	Parameter	Conditions	T <sub>A</sub> +25°C Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_I = 0v OR V_{CC}, V_{CC} = 1.8V, 2.5V or 3.3V$	6	pF
C <sub>OUT</sub>	Output Capacitance	$V_I = 0V \text{ or } V_{CC}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	7	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_1 = 0V \text{ or } V_{CC}, f = 10 \text{ MHz}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	20	pF

### AC Loading and Waveforms (V $_{CC}$ 3.3V $\pm$ 0.3V to 1.8V $\pm$ 0.15V)

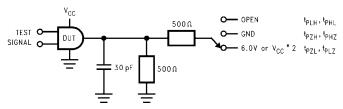


FIGURE 1. AC Test Circuit

TEST	SWITCH
t <sub>PZL</sub> , t <sub>PLZ</sub>	6V at $V_{CC} = 3.3 \pm 0.3V$ ;
	$V_{CC} \times 2$ at $V_{CC} = 2.5V \pm 0.2V$ ; 1.8V

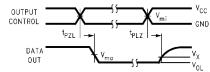
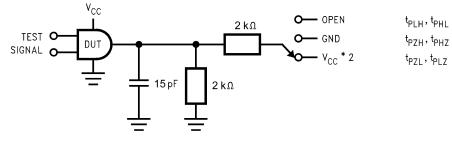


FIGURE 2. Waveform for Open Drain, Inverting and Non-inverting Functions

Symbol		v <sub>cc</sub>	
Cymbol	3.3V ± 0.3V	$\textbf{2.5V} \pm \textbf{0.2V}$	1.8V ± 0.15V
V <sub>mi</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
V <sub>mo</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
V <sub>x</sub>	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.15V	V <sub>OL</sub> + 0.15V

### AC Loading and Waveforms (V $_{\text{CC}}$ 1.5 $\pm$ 0.1V)



TEST	SWITCH	
$t_{PZL}, t_{PLZ}$	$V_{CC}$ x 2 at $V_{CC}$ = 1.5V $\pm$ 0.1V	
FIGURE 3. AC Test Circuit		

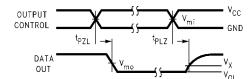
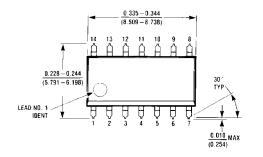
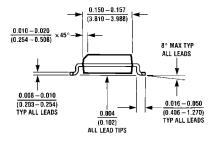


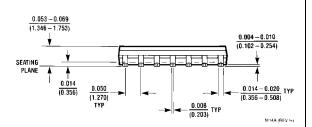
FIGURE 4. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

Symbol	V <sub>cc</sub>
Cymbol	1.5V ± 0.1V
V <sub>mi</sub>	V <sub>CC</sub> /2
V <sub>mo</sub>	V <sub>CC</sub> /2
V <sub>X</sub>	V <sub>OL</sub> +0.1V
V <sub>Y</sub>	V <sub>OH</sub> −0.1V

### Physical Dimensions inches (millimeters) unless otherwise noted

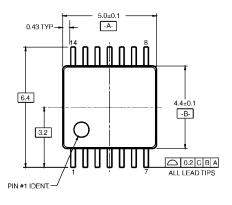


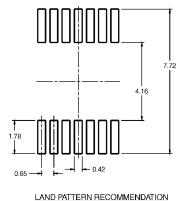


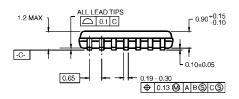


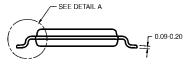
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M14A

### Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





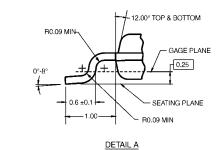




NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATE 7/93.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC14RevC3



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

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